

Nch 45V 2.5A Small Signal MOSFET

Datasheet

-			●Outline	9		
	V _{DSS}	45V	SOT-346T			
-	R _{DS(on)} (Max.)	130mΩ	SC-96		(3)	
-	ا _D	±2.5A	TSMT3	(1)		
-	P _D	1.0W			(2)	
			●Inner o	sircuit		
●Fea	atures			moun	(2)	
	w on-resistance					
2) Bu	illt-in G-S protection dio	de			(1) Gat	
3) Sr	nall surface mount pack	age(TSMT3)		(1)•	(2) Sou (3) Dra	
					*1 *1 ESD Pro	otection
					Diode *2 Body Di	ode
					(2)	
			● Packa	ging spec	cifications	1
			0	Packing		Embossed Tape
				Reel size	e (mm)	180
●Ap	plication		Туре	Tape wic	lth (mm)	8
Switc	ching			Basic or	dering unit (pcs)	3000
	0			Taping c	ode	TL
				Marking		PW
• Ab	solute maximum ratin	gs ($T_a = 25^{\circ}C$, unless otherw	vise specified))		
	Param	eter	Syr	nbol	Value	Unit
Drain	- Source voltage		V	DSS	45	V
Conti	inuous drain current			I _D	±2.5	A
Pulse	ed drain current		I _C)P ^{*1}	±10	A
Gate	- Source voltage		V	GSS	±12	V
Dour			P	D*2	1.0	W
FUW	er dissipation		P _D ^{*3} 0.7 W			W

	P _D ³	0.7	W
Junction temperature	Tj	150	C°
Operating junction and storage temperature range	T _{stg}	-55 to +150	Э°

•Thermal resistance

Parameter			Cumph of		Values		
Paramete	er		Symbol	Min.	Тур.	Max.	Unit
			R_{thJA}^{*2}	-	-	125	°C/W
Thermal resistance, junction - a	mblent		R _{thJA} *3	-	-	178	°C/W
•Electrical characteristics (1	- a = 25°C)				6	0	
Parameter	Symbol	Cor	nditions		Values		Unit
	,			Min.	Тур.	Max.	
Drain - Source breakdown voltage	V _{(BR)DSS}	V _{GS} = 0V, I	_D = 1mA	45	-	-	V
Breakdown voltage	$\Delta V_{(BR)DSS}$	I _D = 1mA		_	46.8	-	mV/°C
temperature coefficient	ΔT_{j}	referenced		10.0			
Zero gate voltage drain current	I _{DSS}	V _{DS} = 45V,	V _{GS} = 0V		-	1	μA
Gate - Source leakage current	I _{GSS}	$V_{GS} = \pm 12$	/, V _{DS} = 0V		-	±10	μA
Gate threshold voltage	V _{GS(th)}	V _{DS} = 10V,	I _D = 1mA	0.5	-	1.5	V
Gate threshold voltage	$\Delta V_{GS(th)}$	I _D = 1mA	0.	-	-3.9	-	mV/°C
temperature coefficient	ΔT_j	referenced					
		V _{GS} = 4.5V	, I _D = 2.5A	-	95	130	
Static drain - source on - state resistance	R _{DS(on)} *4	V _{GS} = 4.0V	, I _D = 2.5A	-	100	140	mΩ
		V _{GS} = 2.5V	, I _D = 2.5A	-	125	175	
Gate resistance	R _G	f = 1MHz, o	pen drain	-	9.2	-	Ω
Forward Transfer Admittance	Y _{fs} *4	V _{DS} = 10V,	I _D = 2.5A	2.0	-	-	S
Admittance							-

*1 Pw≦10μs, Duty cycle≦1%

*2 Mounted on a ceramic board (30x30x0.8mm)

*3 Mounted on a FR4 (25x25x0.8mm)

*4 Pulsed



•Electrical characteristics (T_a = 25°C)

				Values			
Parameter	Symbol	Conditions	Min. Typ. Max.		Unit		
Input capacitance	C _{iss}	V _{GS} = 0V	-	250	-		
Output capacitance	C _{oss}	V _{DS} = 10V	-	60	-	pF	
Reverse transfer capacitance	C _{rss}	f = 1MHz	-	30	-		
Turn - on delay time	t _{d(on)} *4	$V_{DD} \simeq 25 V, V_{GS} = 4.5 V$	-	9	-		
Rise time	t _r *4	I _D = 1.2A	-	15	-		
Turn - off delay time	t _{d(off)} *4	R _L ≃ 20.8Ω	0	20	-	ns	
Fall time	t _f *4	R _G = 10Ω		14	-		
• Gate charge characteristics ($T_a = 25^{\circ}C$)							
				Values			

• Gate charge characteristics (T_a = 25°C)

Parameter	Symbol	nbol Conditions Values				Unit
	Symbol	Conditions	Min.	Тур.	Max.	Unit
Total gate charge	Q _g *4	V _{DD} ≃ 25V,	-	3.2	-	
Gate - Source charge	Q _{gs} *4	I _D = 2.5A,	-	0.9	-	nC
Gate - Drain charge	Q _{gd} *4	V _{GS} = 4.5V	-	0.7	-	

•Body diode electrical characteristics (Source-Drain) ($T_a = 25^{\circ}C$)

Parameter	Symbol	Conditions		Values		- Unit	
Palameter	Symbol	Conditions	Min.	Тур.	Max.	Unit	
Continuous forward current	۱ _s	$T = 25^{\circ}$	-	-	0.8	А	
Pulse forward current	I_{SP}^{*1}	T _a = 25°C	-	-	10	А	
Forward voltage	V _{SD} *4	V _{GS} = 0V, I _S = 2.5A	-	-	1.2	V	

4



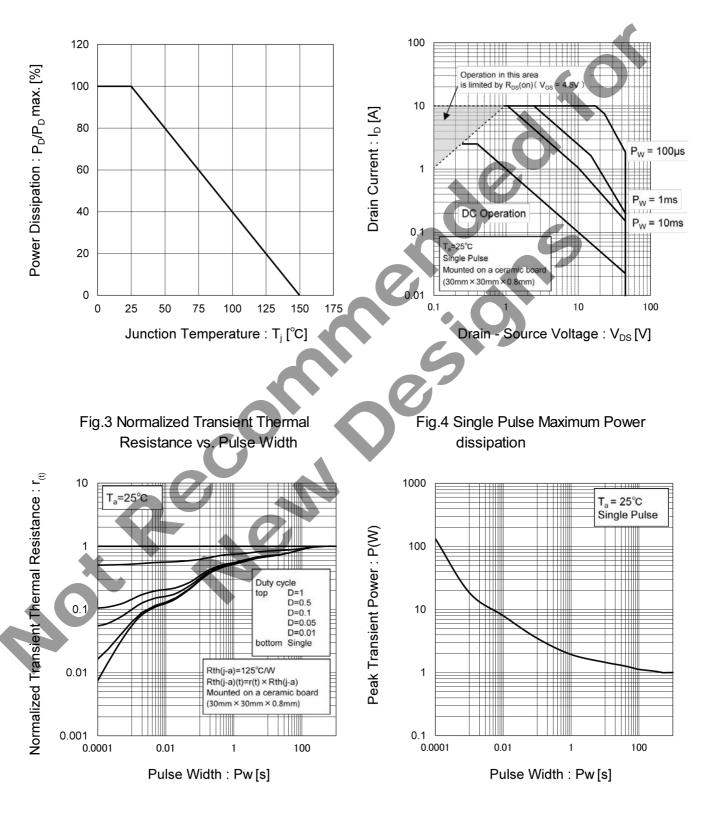


Fig.1 Power Dissipation Derating Curve

Fig.2 Maximum Safe Operating Area





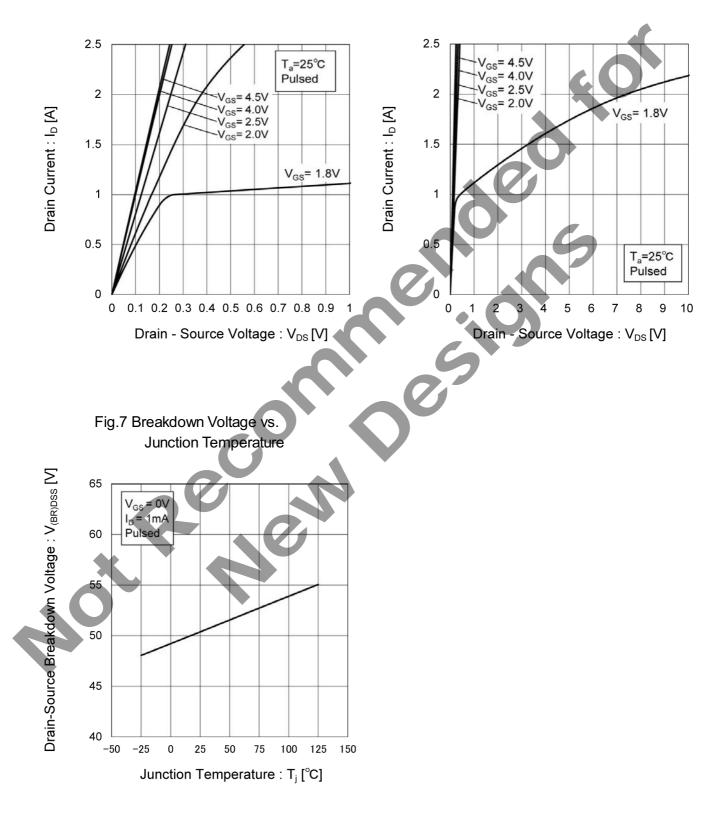
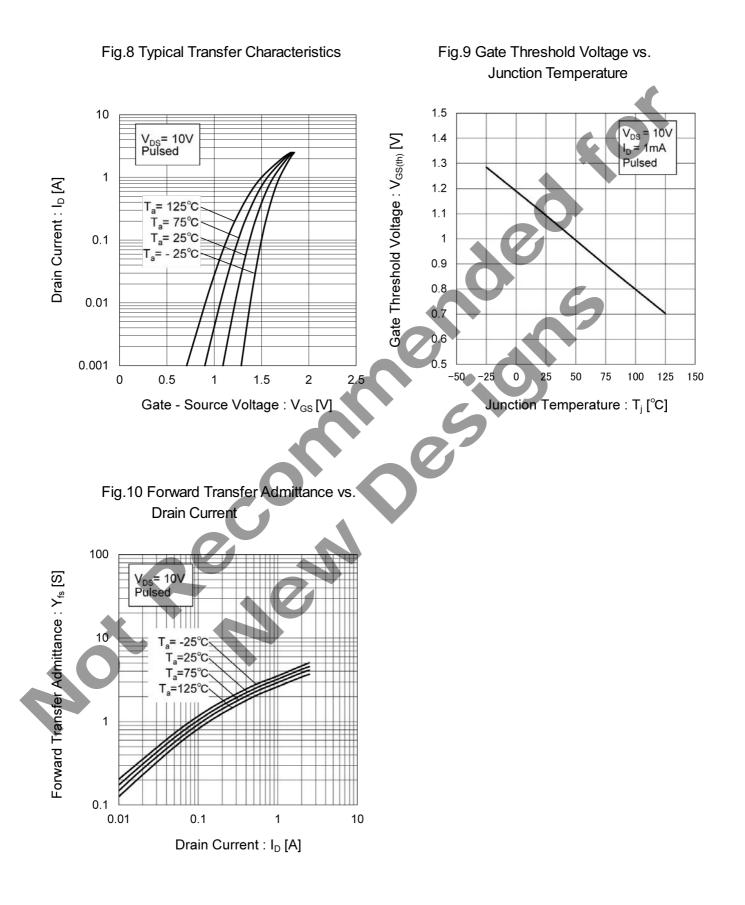


Fig.5 Typical Output Characteristics(I)

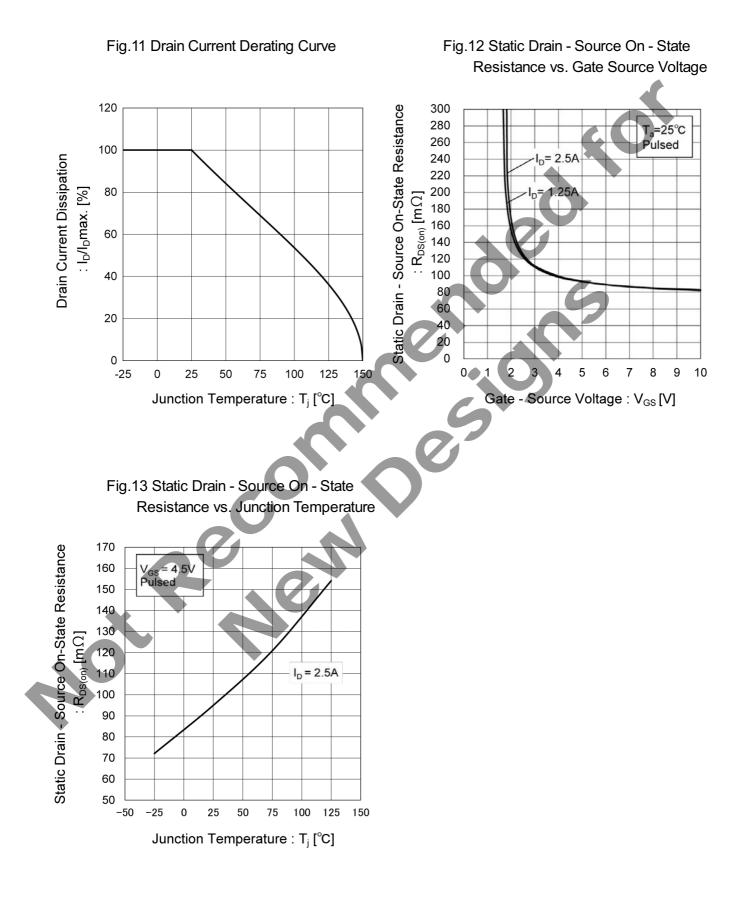
Fig.6 Typical Output Characteristics(II)













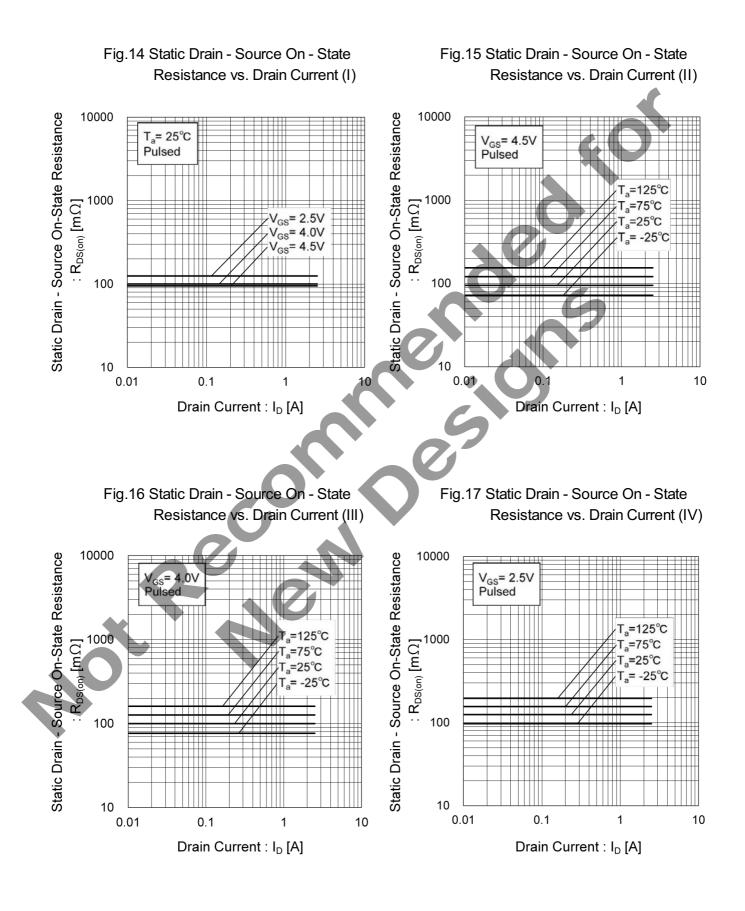




Fig.18 Typical Capacitance vs.

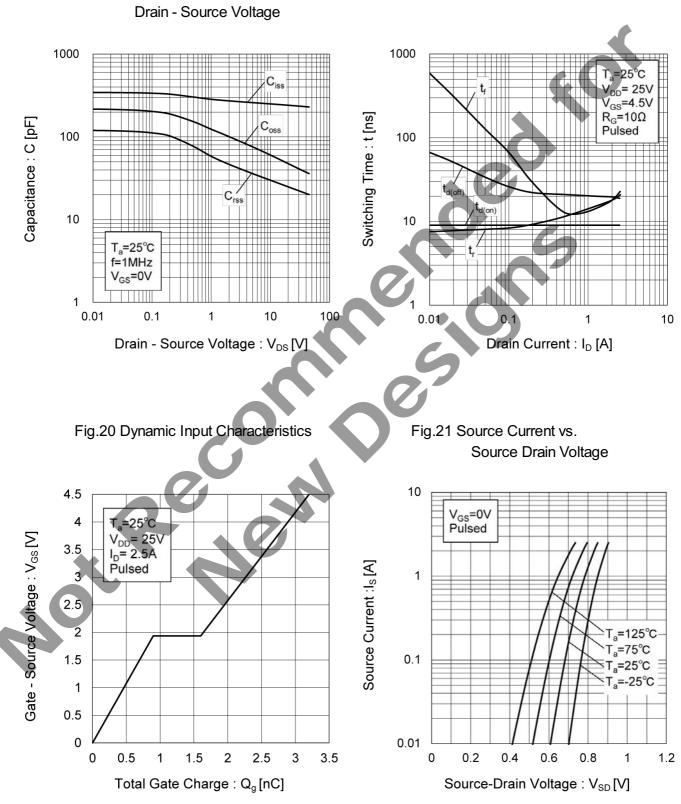
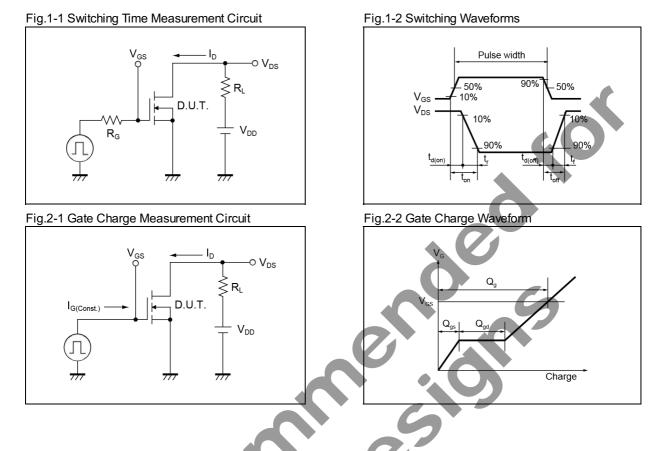


Fig.19 Switching Characteristics



Measurement circuits



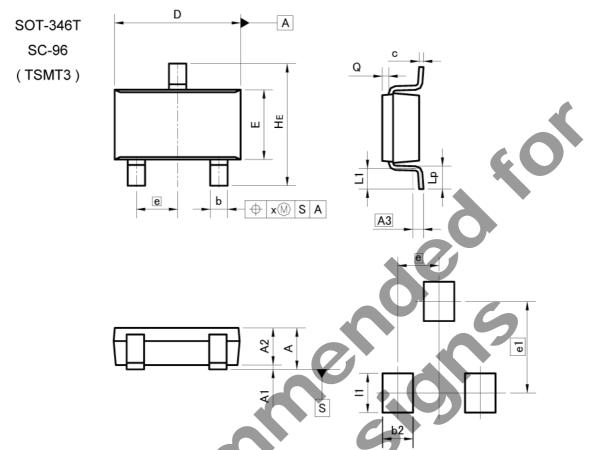
Notice

This product might cause chip aging and breakdown under the large electrified environment. Please consider to design ESD protection circuit.





Dimensions



Pattern of terminal position areas [Not a pattern of soldering pads]

DIM	MILIM	ETERS	INC	HES	
DIW	MIN	MAX	MIN	MAX	
A	-	1.00	-	0.039	
A1	0.00	0.10	0.000	0.004	
A2	0.75	0.95	0.030	0.037	
A3	0,	25	0.0	010	
b	0.35	0.50	0.014	0.020	
c	0.10	0.26	0.004	0.010	
D	2.80	3.00	0.110	0.118	
E	1.50	1.80	0.059	0.071	
е	0,	95	0.037		
HE	2.60	3.00	0.102	0.118	
L1	0.30	0.60	0.012	0.024	
Lp	0.40	0.70	0.016	0.028	
Q	0.05	0.25	0.002	0.010	
х	7.79	0.20		0.008	

DIM	MILIMETERS		INCHES		
	MIN	MAX	MIN	MAX	
b2		0.70	57.55	0.028	
e1	2.10		0.0	083	
11		0.90	1 7%	0.035	

Dimension in mm/inches



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(Note1) Medical Equipment Classification of the Specific Application					
	JAPAN	USA	EU	CHINA	

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CLASS II b

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 - [b] Use of our Products outdoors or in places where the Products are exposed to direct sunlight or dust
 - [c] Use of our Products in places where the Products are exposed to sea wind or corrosive gases, including Cl₂, H₂S, NH₃, SO₂, and NO₂
 - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
 - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
 - [f] Sealing or coating our Products with resin or other coating materials
 - [g] Use of our Products without cleaning residue of flux (even if you use no-clean type fluxes, cleaning residue of flux is recommended); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
 - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.

CLASS III

CLASSIV

- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse. is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power, exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.

De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.

- 8. Confirm that operation temperature is within the specified range described in the product specification.
- 9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

Precaution for Mounting / Circuit board design

- 1. When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- 2. In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

Precautions Regarding Application Examples and External Circuits

- 1. If change is made to the constant of an external circuit, please allow a sufficient margin considering variations of the characteristics of the Products and external components, including transient characteristics, as well as static characteristics.
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Precaution for Electrostatic

This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

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- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
 - [a] the Products are exposed to sea winds or corrosive gases, including Cl2, H2S, NH3, SO2, and NO2
 - [b] the temperature or humidity exceeds those recommended by ROHM
 - [c] the Products are exposed to direct sunshine or condensation
 - [d] the Products are exposed to high Electrostatic
- 2. Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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